CBTech® 川寶科技股份有限公司
CHIME BALL TECHNOLOGY CO LTD.

創新
Create

卓越
Best

科技
Technology

Investor Conference

Stock Symbol: 1595

Presented by : Wonder Chang, the Chairman of CBT
Ray Lu, the CEO of CBT

May 27th, 2024

This presentation, which included statements regarding its results of operations, financial conditions, and business prospects, are only based on the Company’ s estimates and expectations and are for reference only. Any business outlook or forward-looking statement hereof is subject to change after this date. Except as required by law, we undertake no obligation to update any forward-looking statement, whether as a result of new information, future events, or otherwise.

Outline

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Group Introduction

CBT GROUP VISION

To Become The Best of IT Fabrication ECOSystem Solution Provider

Group Members and Key Affiliated Enterprises

CBT Group

Chime Ball Technology Co., Ltd.	Flexible/Rigid PCB Exposure Units Flexible PCB RTR Exposure Units Flexible/Rigid PCB LDI/Solder Mask DI Exposure Units
Bao Hong Semi Tech Co., Ltd.	Wafer Manufacturing Units Handling Systems in Wafer Fab Key Parts Supplier
CBT International (SH) Co., Ltd.	International Trading Company for Parts Sales Maintenance After-Sales Service
Bao Hua Technology Co., Ltd.	SEMI AOI Automated Software Development
Pure Metallica Co., Ltd.	PEALD/ALE Thin Film/Etch Process Application PEALD/ALE Thin Film/Etch Process Patent Portfolio

The Best of IT Fabrication ECOSystem Solution Provider

Lithography Solutions

Supplies DI Exposure Unit Equipment, Services and Software for Manufacture of PCB industry & Semi 2D/3D Chip Package.

Semi Equipment Solutions

Supplies 8” & 12” Mature Process Equipment, Services and Software for the Manufacture of Semiconductor Chips.

AOI Solutions, (Automated Optical Inspection)

Supplies AOI equipment, services and software for the manufacture of front / back end inspection solution.

Critical Materials & Coating Solutions

Dedicated on Advanced Surface Treatment (AST) Technologies for Metallic Alloys solutions

ESG
Zero Waste Solution

Provide green manufacturing electronic-grade sulfuric acid recycling system to minimize waste and maximize sustainable use of resources

AI ?

CBT Group Regional HQ Worldwide & Company location Map

In order to meet the needs of the PCB/semiconductor industry, CBT group has established 5 service points with high-quality service and sales network around the world.

- ✓ *Taiwan*
- ✓ *China*
- ✓ *South Korea*
- ✓ *Thailand*
- ✓ *USA*

Santa Clara, CA

Bangkok, Thailand

Dongguan, China

Kunshan, China

Taoyuan City, Taiwan

Hsinchu City, Taiwan

Financial Overview

2021~2024 Q1 Consolidated Revenue, Gross Margin, Net Profit Margin, EPS and Dividend Yield

Unit: NT$ thousand

Account	2021	2022	2023	2024'Q1
Consolidated Revenue	2,417,036	1,795,723	1,407,762	207,120
Gross Margin	25%	27%	27%	33%
Net Profit Margin	8%	13%	3%	8%
EPS	3.93	4.85	1.04	0.36
Dividend Yield	1.38%	5.43%	5.01%	-
BVPS	53.65	56.50	55.34	54.77

Consolidated Income Statement for 2023 Q1 and 2024 Q1

Account	2023 Q1	%	2024 Q1	%	YoY
Operating Revenue	318,555	100%	207,120	100%	-35%
Gross Profit	100,478	32%	68,877	33%	-31%
Operating Expense	(78,222)	-25%	(74,631)	-36%	-5%
Net Operating Profit	22,256	7%	(5,754)	-3%	-126%
Non-Operating Income and Expenditure	(2,738)	-1%	32,266	16%	1278%
Net Profit before Tax	19,518	6%	26,512	13%	36%
Income Tax Expense	(7,687)	-2%	(9,569)	-5%	24%
Profit after Tax	11,831	4%	16,943	8%	43%
EPS	0.27		0.36		33%

Unit: NT$ thousand

Consolidated Balance Sheet 2023 Q1、2023 Q4 and 2024 Q1

Unit: NT$ thousand

Account	2023 Q1	%	2023 Q4	%	2024 Q1	%
Cash and Cash Equivalents	1,330,843	27%	988,138	23%	798,721	18%
Financial Assets Measured at Amortized Cost-Current Assets	30,450	1%	120,105	3%	217,400	5%
Accounts Receivable	419,470	8%	319,565	7%	361,821	8%
Inventories	1,808,189	36%	1,474,410	34%	1,445,462	33%
Other Current Assets	145,627	3%	102,590	2%	98,520	2%
Financial Asset or Financial Liability at Aair Value-Non Current	-	0%	2,090	0%	2,090	0%
Measured at Fair Value through Other Comprehensive Income-Non Current	80,405	2%	76,796	2%	76,867	2%
Financial Assets Measured at Amortized Cost-Non Current	29,104	1%	29,779	1%	91,035	2%
Class of Property, Plant and Equipment	794,806	16%	847,762	19%	858,674	20%
Right-of-Use Asset	16,175	0%	17,347	0%	15,890	0%
Goodwill	213,440	4%	213,440	5%	213,440	5%
Intangible asset	122,041	2%	97,381	2%	90,414	2%
Other Non Current Assets	7,511	0%	92,688	2%	72,811	2%
Total Assets	4,998,061	100%	4,382,091	100%	4,343,145	100%

Consolidated Balance Sheet 2023 Q1、2023 Q4 and 2024 Q1

Unit: NT$ thousand

Account	2023 Q1	%	2023 Q4	%	2024 Q1	%
Current Liabilities	2,139,959	43%	1,372,763	31%	1,389,433	32%
Non-Current Liabilities	257,228	5%	361,242	8%	3,28,590	8%
Total Liabilities	**2,397,187**	**48%**	**1,734,005**	**40%**	**1,718,023**	**40%**
Common Stock	474,226	9%	477,861	11%	478,754	11%
Additional Paid-In Capital	567,379	11%	575,534	13%	577,432	13%
Retained Earnings	1,552,004	31%	1,588,633	36%	1,558,091	36%
Other Equity	4,205	0%	2,653	0%	7,741	0%
Non-Controlling Interest	3,060	0%	3,405	0%	3,104	0%
Total Equities	**2,600,874**	**52%**	**2,648,086**	**60%**	**2,625,122**	**60%**

Future Outlook

Operational Plan for Next 5 Years

Printed Circuit Board (PCB) Industry

佈局先進載板市場，開發載板LDI/Stepper曝光設備及相關AVI
自動視覺檢查設備產品，封裝用曝光設備開發。

Semi Equipment Industry

前段再生成熟製程12” CVD 設備開發，TGV Sputer濺
鍍設備開發，IC老化爐代理銷售服務業務.

Semi Critical Components

先進製程關鍵零組件鍍膜零件業務。

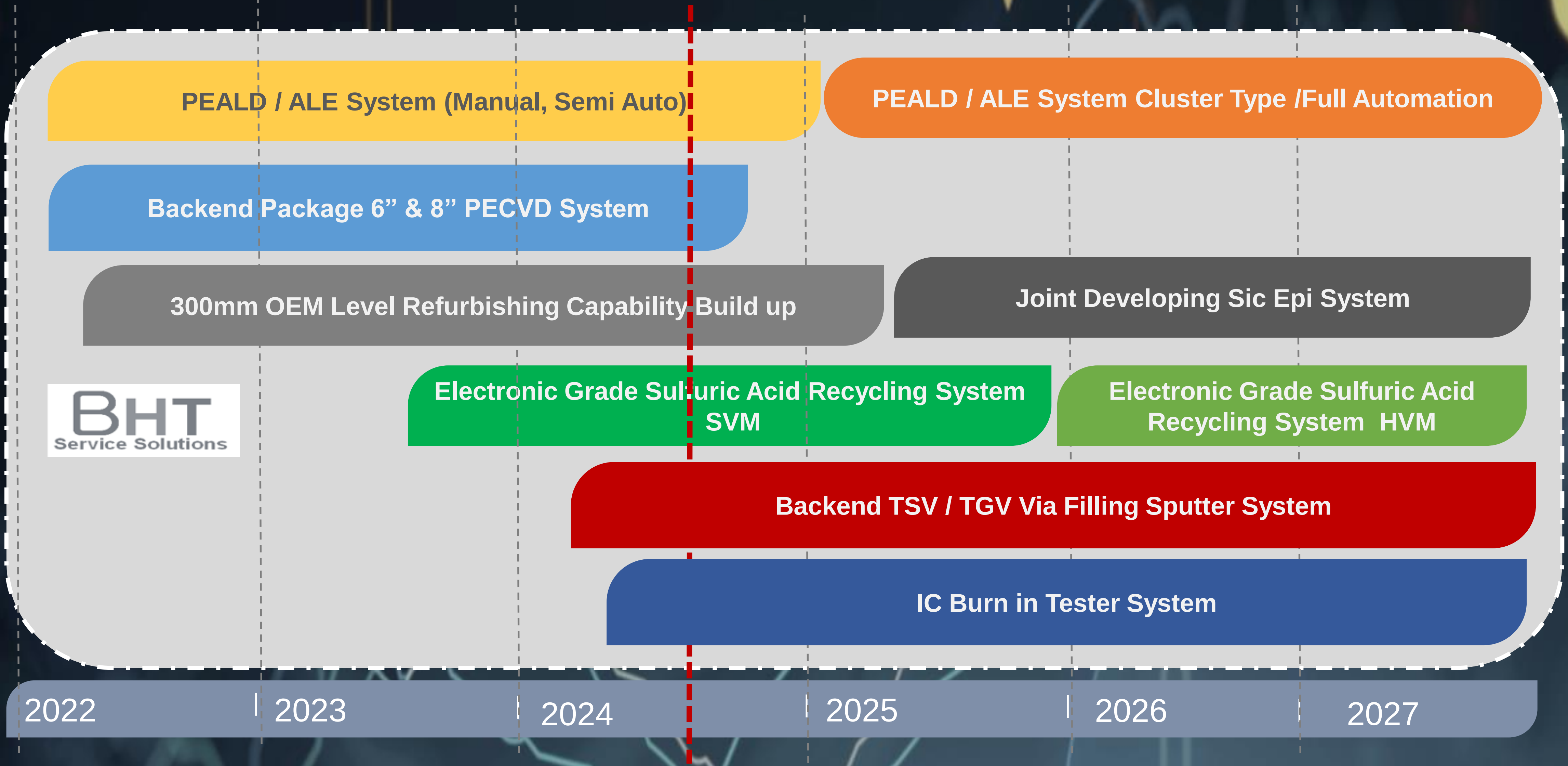
半導體電子級硫酸回收業務

先進製程半導體電子級硫酸回收設備銷售業務。

1.
Printed Circuit Board (PCB) Industry

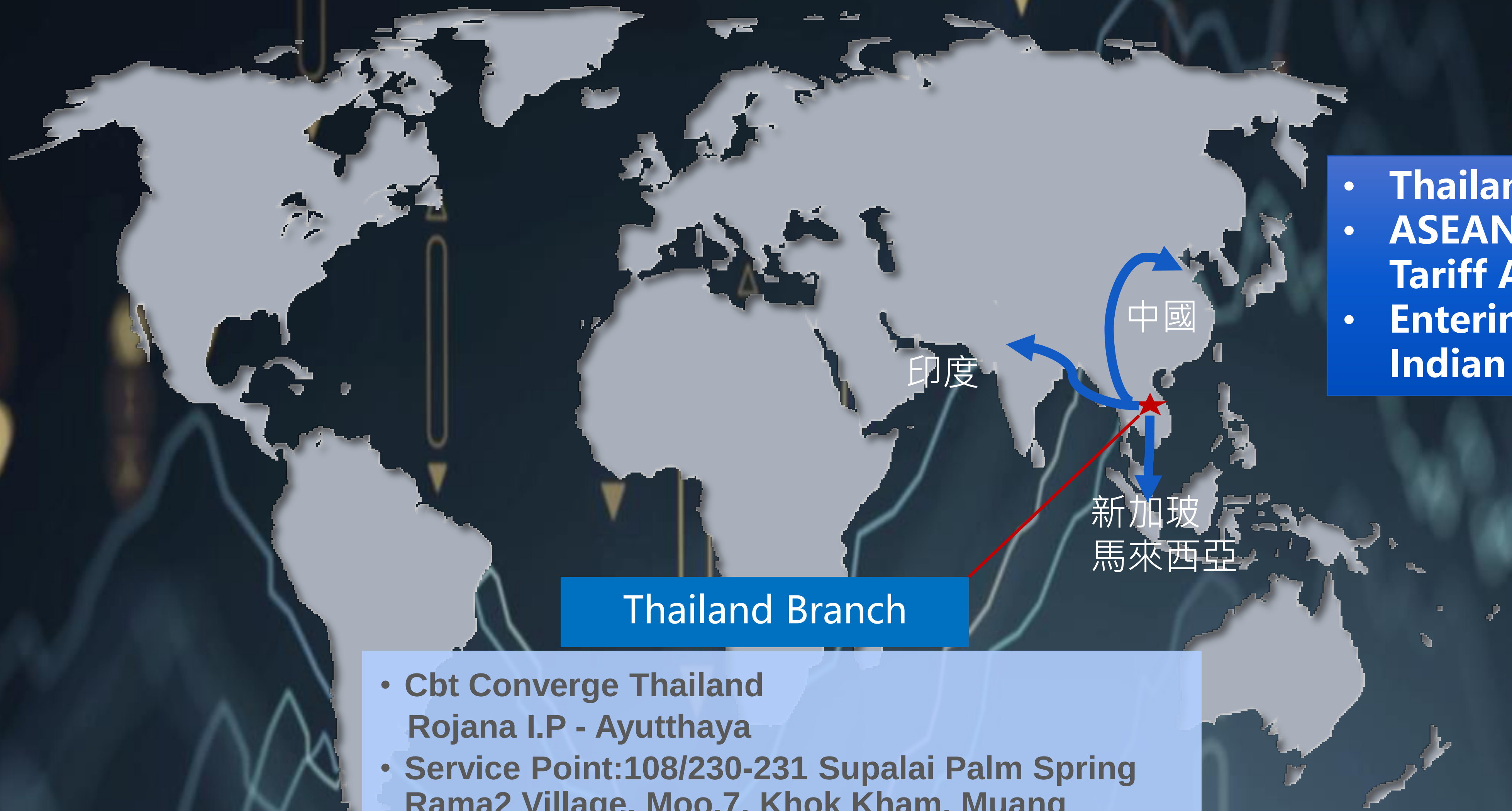
Time	Model	Light Source	Application
2027	Ares S3 (Stepper)	UV LED	ABF
2026	Gemini R50D/R35D/R25D/R8D	405nm Laser	CSP BGA PCB FPC HLC HDI
2025	Gemini CSM50D /TiTAN CSM50 Gemini CSM25D /TiTAN CSM25	Hybrid UV LED+ Laser	
	SEMI X10		MEMS
Now	Gemini 8600SR_F TiTAN 8000PSR_H Raptor 7000 TiTAN 9000 TiTAN 8000	Triple wavelength UV LED	PCB FPC HLC

2.
Semi Equipment Industry



Southeast Asia Layout

Benefit Assessment



- Thailand Market
- ASEAN RCEP Tariff Agreement
- Entering the Indian Market

Thailand Branch

- **Cbt Converge Thailand Rojana I.P - Ayutthaya**
- **Service Point:108/230-231 Supalai Palm Spring Rama2 Village, Moo.7, Khok Kham, Muang Samutsakorn, Samutsakorn 74000**

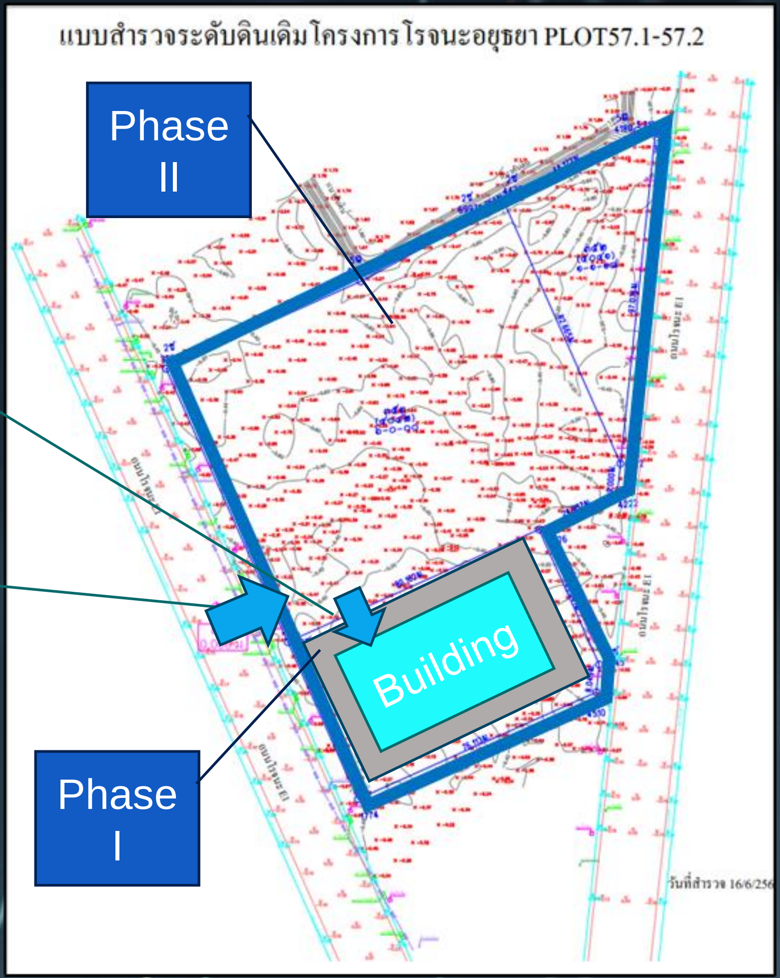
Factory Location

Rojana I.P - Ayutthaya			
Plot	rai	SQM	ping
57.1	2.5	4,000	1210
57.2	7.3	11,680	3533.2
	9.8	15,680	4,743

2024/4/E obtained Thailand BOI investment preferential A1 qualification approval

Building Scale and Dimensions Phase I

1. **Total Space of phase I building: 4000SQM**
2. **Number of Floor: 1 floor**
3. **Height Limitation: N/A**



CBT Converge Thailand

2024.06	2024.12	2025.01	2025.08	2025.12	2026.03
Planning	Design Complete	Contract Signed Construction Start	Construction Complete	Acceptance	Operation Start
基地確定 初步配置 承包商選定 地質探勘	Layout確定 細部設計 開挖圖說 建照申請	整地 動土典禮 建築發包 機電發包	基礎施工 外牆安裝 土建移交 機電安裝 水電申請	使照申請 搬入設備	運作使用

◆ 12 months for construction, architecture design and license application are not included.

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